



BC846xQC-Q series

65 V, 100 mA NPN general-purpose transistor

Rev. 1 — 4 March 2021

Product data sheet

1. General description

NPN general-purpose transistor in an ultra small DFN1412D-3 (SOT8009) leadless Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

Table 1. Product overview

Type number	Package		PNP complement:
	Nexperia	JEDEC	
BC846AQC-Q	SOT8009	MO-340CA	BC856AQC-Q
BC846BQC-Q			BC856BQC-Q

2. Features and benefits

- High power dissipation capability
- High voltage (max. 65 V)
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- Smaller footprint compared to conventional leaded SMD packages
- Low package height of 0.5 mm
- AEC-Q101 qualified

3. Applications

- General-purpose switching and amplification
- Space restricted applications

4. Quick reference data

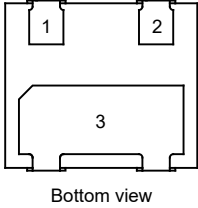
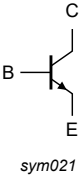
Table 2. Quick reference data

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	65	V
I_C	collector current		-	-	100	mA
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-	200	mA
h_{FE}	DC current gain					
	BC846AQC-Q	$V_{CE} = 5\text{ V}; I_C = 2\text{ mA}$	110	-	220	
	BC846BQC-Q		200	-	450	

5. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 <p>Bottom view</p>	 <p>sym021</p>
2	E	emitter		
3	C	collector		

6. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
BC846AQC-Q	DFN1412D-3	plastic, leadless ultra small outline package with sidewettable flanks (SWF); 3 terminals; 0.8 mm pitch; 1.4 mm x 1.2 mm x 0.48 mm body	SOT8009
BC846BQC-Q			

7. Marking

Table 5. Marking

Type number	Marking code
BC846AQC-Q	9R
BC846BQC-Q	9S

8. Limiting values

Table 6. Limiting values

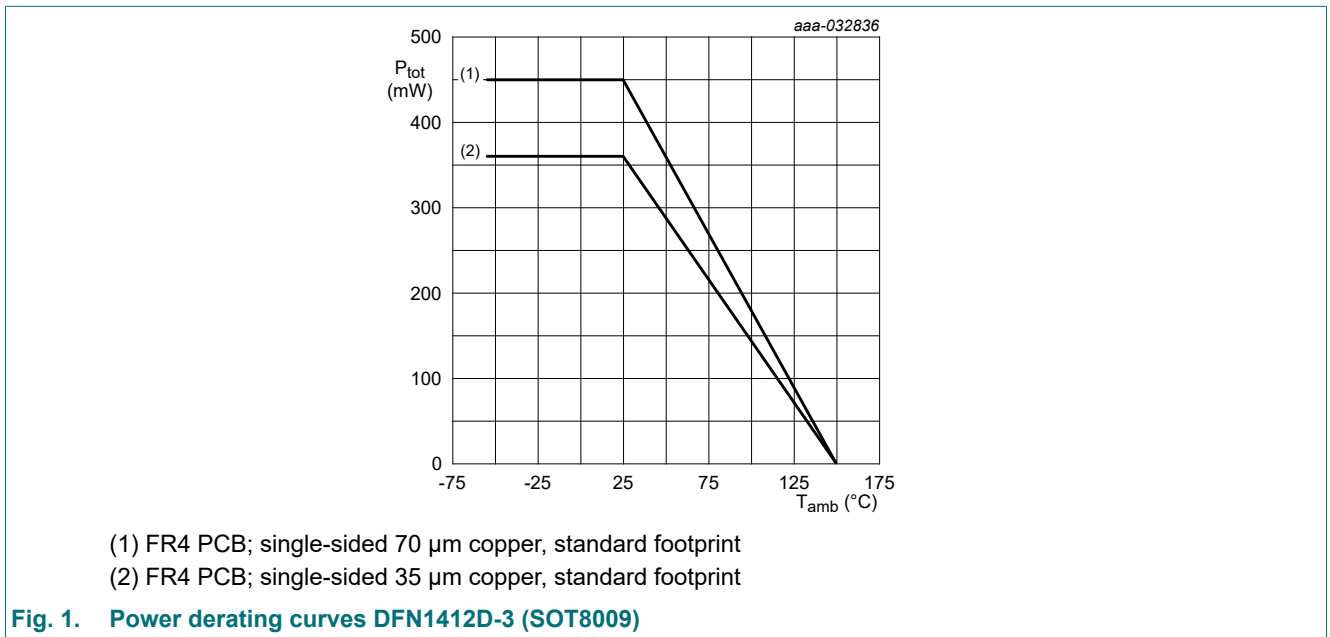
In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit	
V_{CBO}	collector-base voltage	open emitter	-	80	V	
V_{CEO}	collector-emitter voltage	open base	-	65	V	
V_{EBO}	emitter-base voltage	open collector	-	6	V	
I_C	collector current		-	100	mA	
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	200	mA	
I_{BM}	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	100	mA	
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	360	mW
			[2]	-	450	mW
T_j	junction temperature		-	150	°C	
T_{amb}	ambient temperature		-55	150	°C	
T_{stg}	storage temperature		-65	150	°C	

[1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided 35 μm copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided 70 μm copper; tin-plated and standard footprint.



9. Thermal characteristics

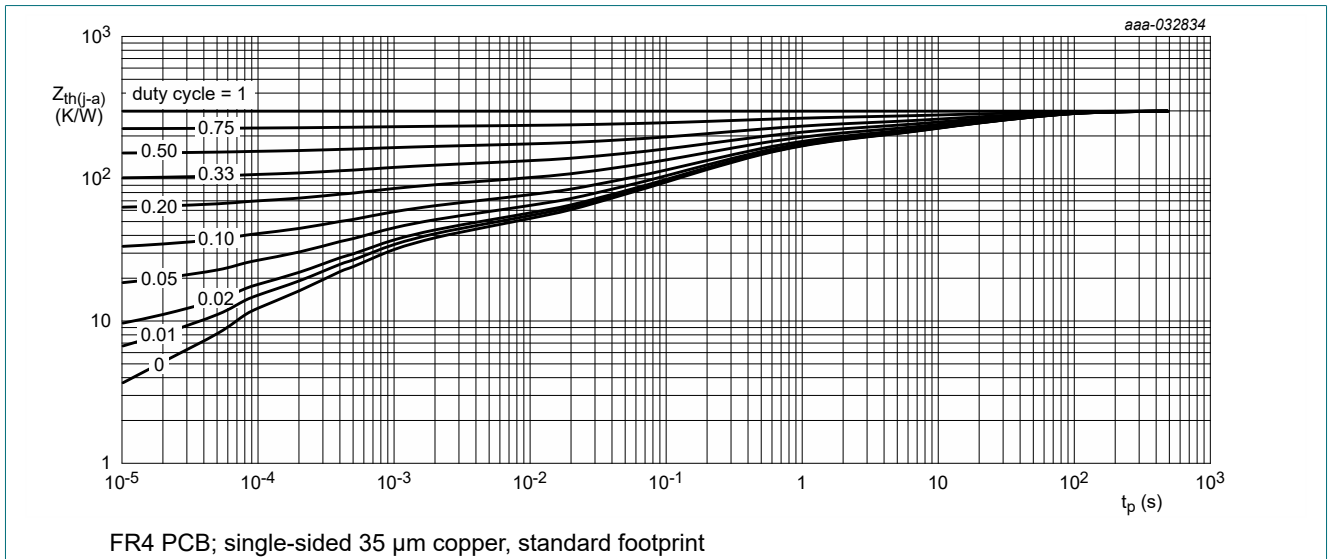
Table 7. Thermal characteristics

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	348	K/W
			[2]	-	-	278	K/W

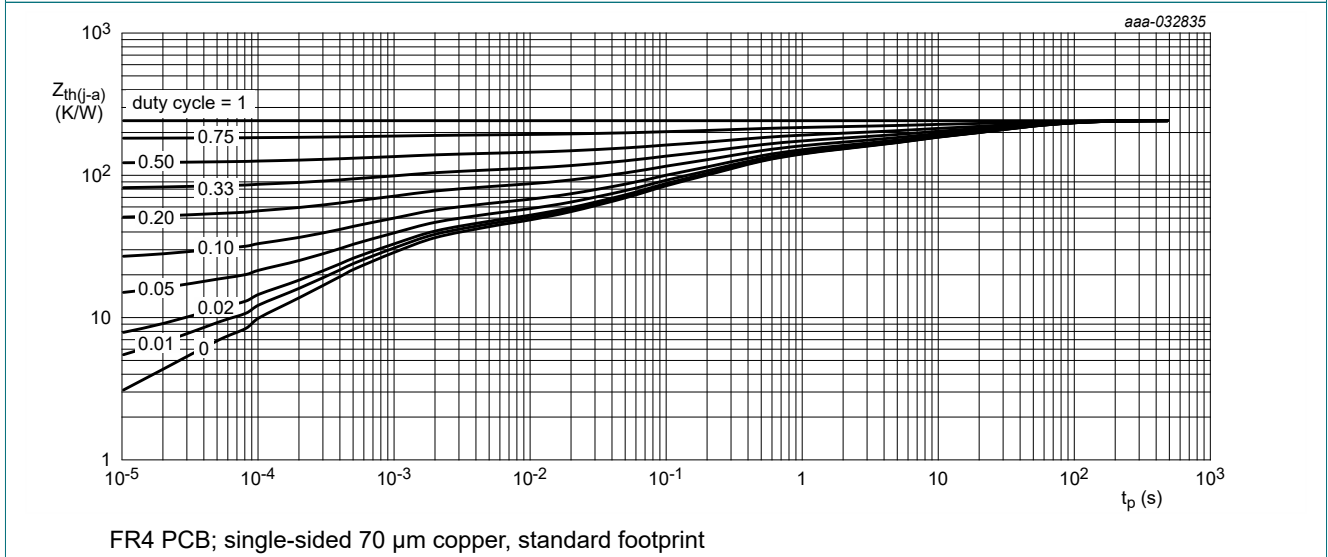
[1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided 35 μm copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided 70 μm copper; tin-plated and standard footprint.



FR4 PCB; single-sided 35 μm copper, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB; single-sided 70 μm copper, standard footprint

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

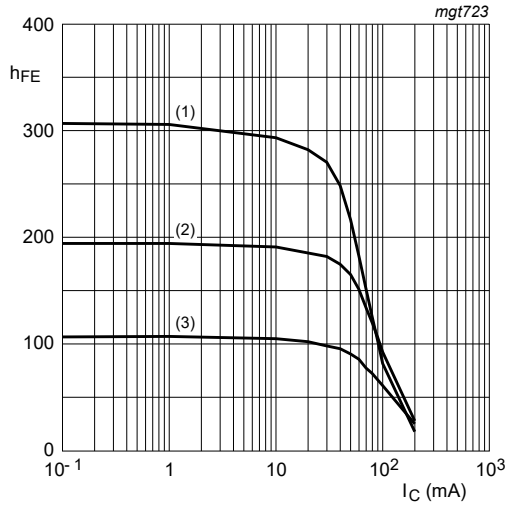
10. Characteristics

Table 8. Characteristics
 $T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100\ \mu\text{A}; I_E = 0\ \text{A}$	80	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2\ \text{mA}; I_B = 0\ \text{A}$	65	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 100\ \mu\text{A}; I_C = 0\ \text{A}$	6	-	-	V
I_{CBO}	collector-base cut-off current	$V_{CB} = 30\ \text{V}; I_E = 0\ \text{A}$	-	-	15	nA
		$V_{CB} = 30\ \text{V}; I_E = 0\ \text{A}; T_j = 150\text{ °C}$	-	-	5	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5\ \text{V}; I_C = 0\ \text{A}$	-	-	100	nA
h_{FE}	DC current gain					
	BC846AQC-Q	$V_{CE} = 5\ \text{V}; I_C = 2\ \text{mA}$	110	-	220	
	BC846BQC-Q		200	-	450	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 10\ \text{mA}; I_B = 0.5\ \text{mA}$	-	-	200	mV
		$I_C = 100\ \text{mA}; I_B = 5\ \text{mA}$ [1]	-	-	400	mV
V_{BE}	base-emitter voltage	$V_{CE} = 5\ \text{V}; I_C = 2\ \text{mA}$ [2]	580	-	700	mV
		$V_{CE} = 5\ \text{V}; I_C = 10\ \text{mA}$ [2]	-	-	770	mV
V_{BEsat}	base-emitter saturation voltage	$I_C = 10\ \text{mA}; I_B = 0.5\ \text{mA}$	-	760	-	mV
		$I_C = 100\ \text{mA}; I_B = 5\ \text{mA}$ [1]	-	900	-	mV
f_T	transition frequency	$V_{CE} = 5\ \text{V}; I_C = 10\ \text{mA}; f = 100\ \text{MHz}$	100	-	-	MHz
C_c	collector capacitance	$V_{CB} = 10\ \text{V}; I_E = I_E = 0\ \text{A}; f = 1\ \text{MHz}$	-	-	3	pF
C_e	emitter capacitance	$V_{EB} = 0.5\ \text{V}; I_E = I_E = 0\ \text{A}; f = 1\ \text{MHz}$	-	11	-	pF
NF	noise figure	$V_{CE} = 5\ \text{V}; I_C = 200\ \mu\text{A}; R_S = 2\ \text{k}\Omega; f = 1\ \text{kHz}; B = 200\ \text{Hz}$	-	-	10	dB

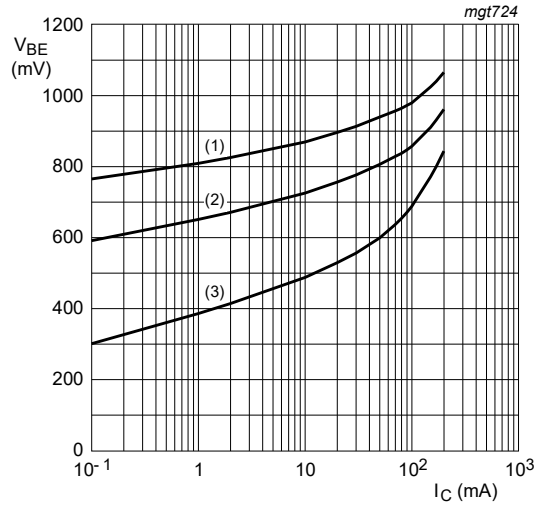
[1] pulsed; $t_p \leq 300\ \mu\text{s}$; $\delta \leq 0.02$

[2] V_{BE} decreases by about 2 mV/K with increasing temperature.



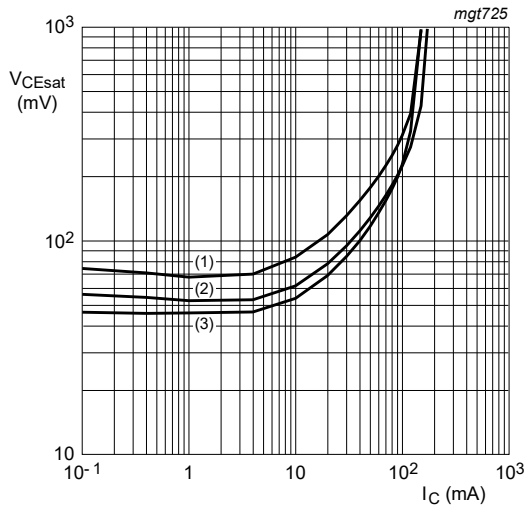
$V_{CE} = 5\text{ V}$
 (1) $T_{amb} = 150\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = -55\text{ °C}$

Fig. 4. BC846AQC-Q: DC current gain as a function of collector current; typical values



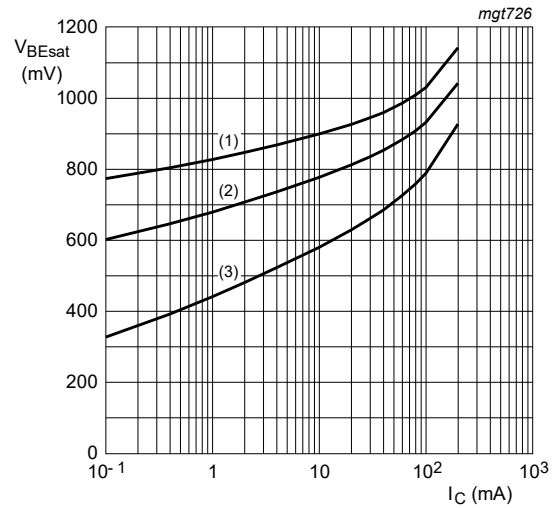
$V_{CE} = 5\text{ V}$
 (1) $T_{amb} = -55\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = 150\text{ °C}$

Fig. 5. BC846AQC-Q: Base-emitter voltage as a function of collector current; typical values



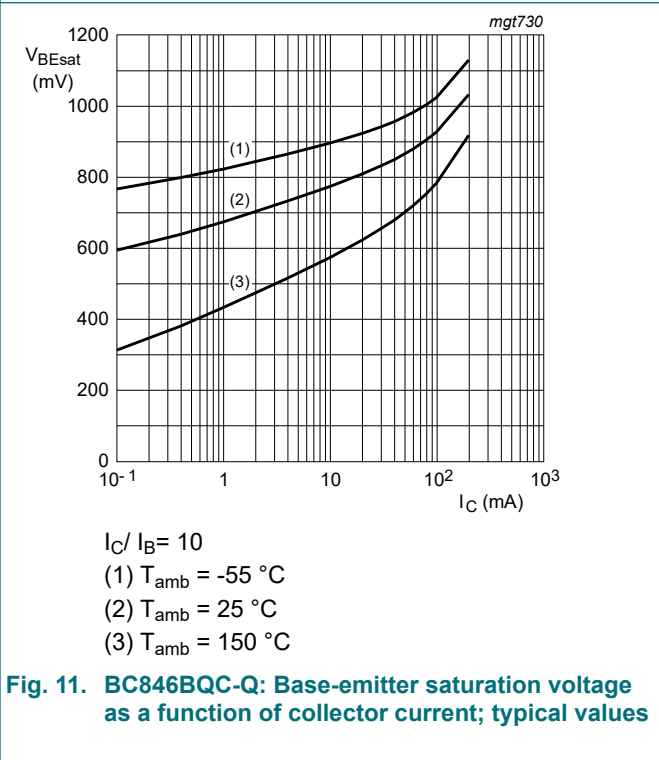
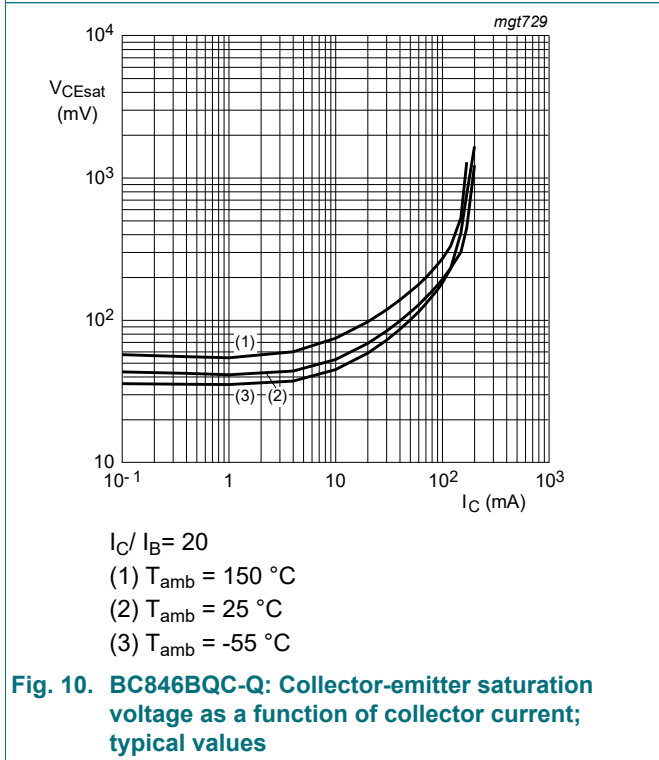
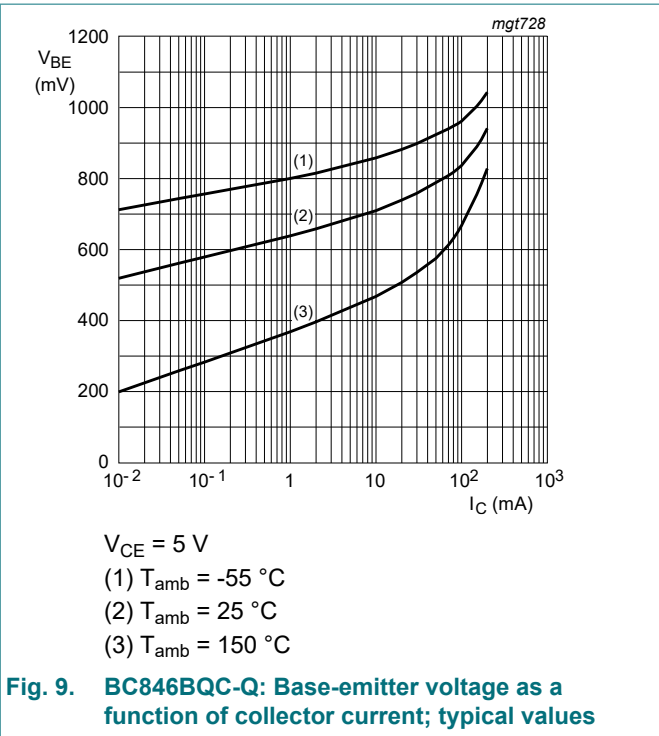
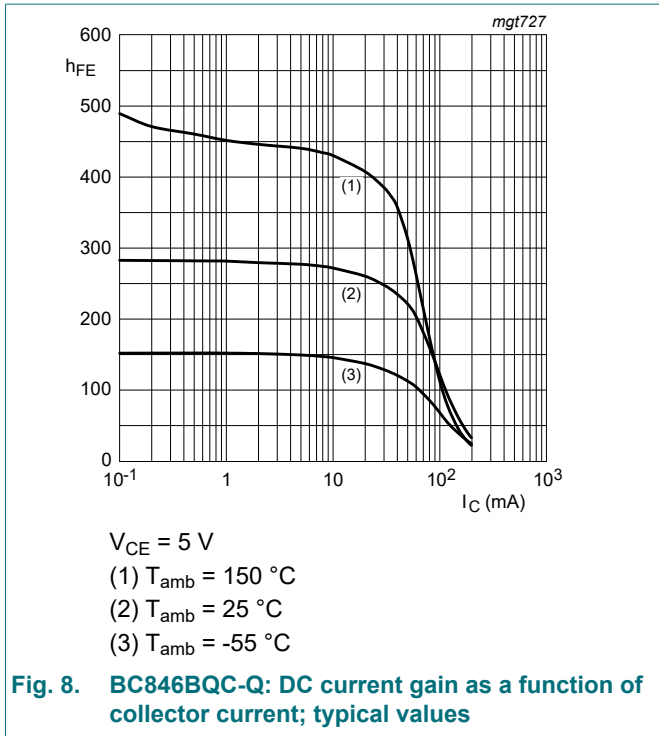
$I_C / I_B = 20$
 (1) $T_{amb} = 150\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = -55\text{ °C}$

Fig. 6. BC846AQC-Q: Collector-emitter saturation voltage as a function of collector current; typical values



$I_C / I_B = 10$
 (1) $T_{amb} = -55\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = 150\text{ °C}$

Fig. 7. BC846AQC-Q: Base-emitter saturation voltage as a function of collector current; typical values



11. Test information

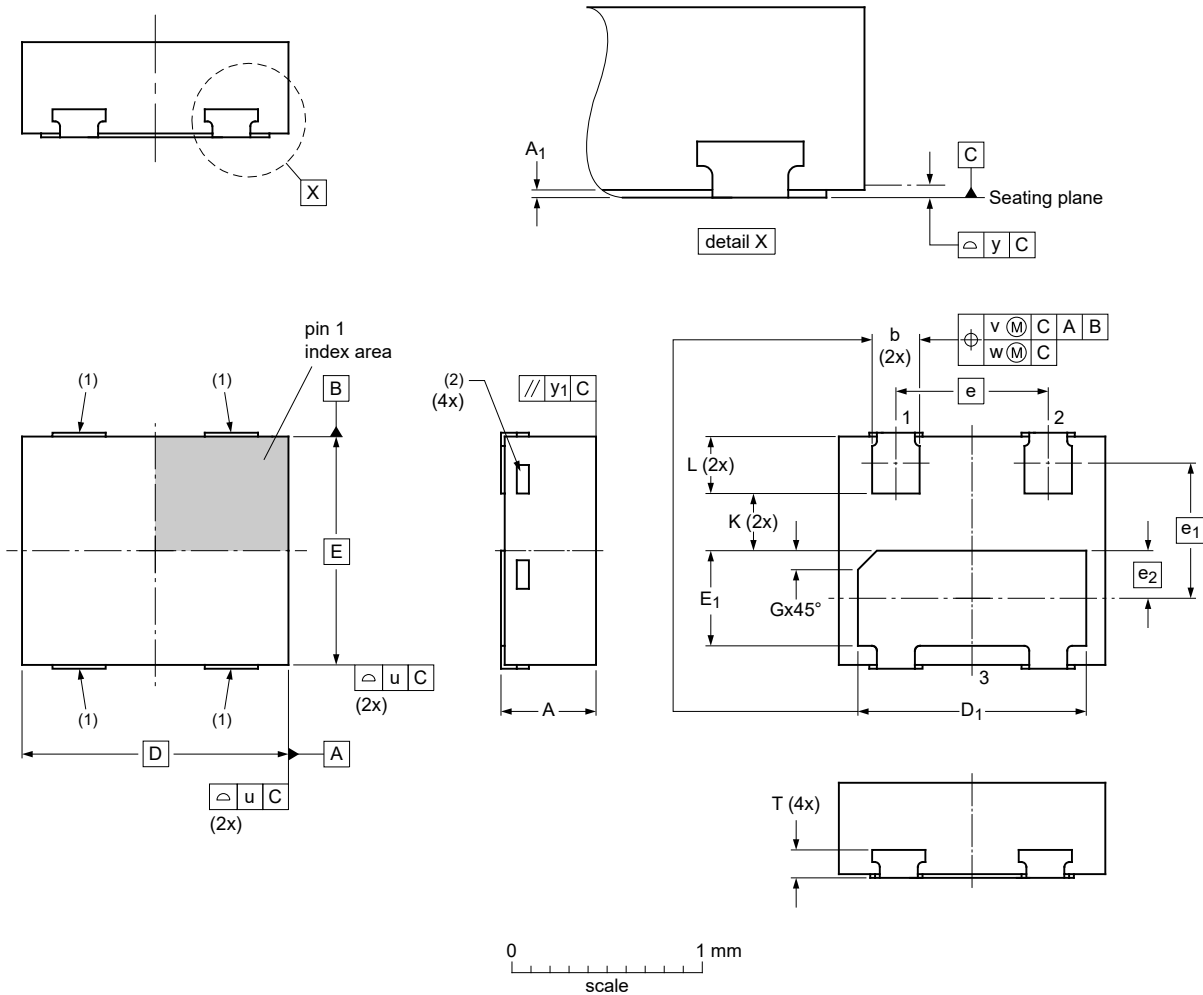
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

DFN1412D-3: plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.8 mm pitch; 1.4 mm x 1.2 mm x 0.48 mm body

SOT8009



Dimensions (mm are the original dimensions)

Unit	A	A ₁	b	D	D ₁	E	E ₁	e	e ₁	e ₂	G	K	L	T	u	v	w	y	y ₁
max	0.50	0.04	0.30	1.25	0.55								0.35	0.22					
nom	0.47		0.25	1.4	1.20	1.2	0.50	0.8	0.71	0.26	0.09		0.30	0.16	0.05	0.1	0.05	0.05	0.05
min	0.44		0.22	1.17	0.47						(ref)	0.25	0.27	0.10					

Note

- 1. Side Wettable Flank, protrusion max. 0.02 mm.
 - 2. Visible depend upon used manufacturing technology.
- Dimension A and T are including plating thickness.

sot8009_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT8009	MO-340CA					19-12-04 19-12-06

Fig. 12. Package outline DFN1412D-3 (SOT8009)

13. Soldering

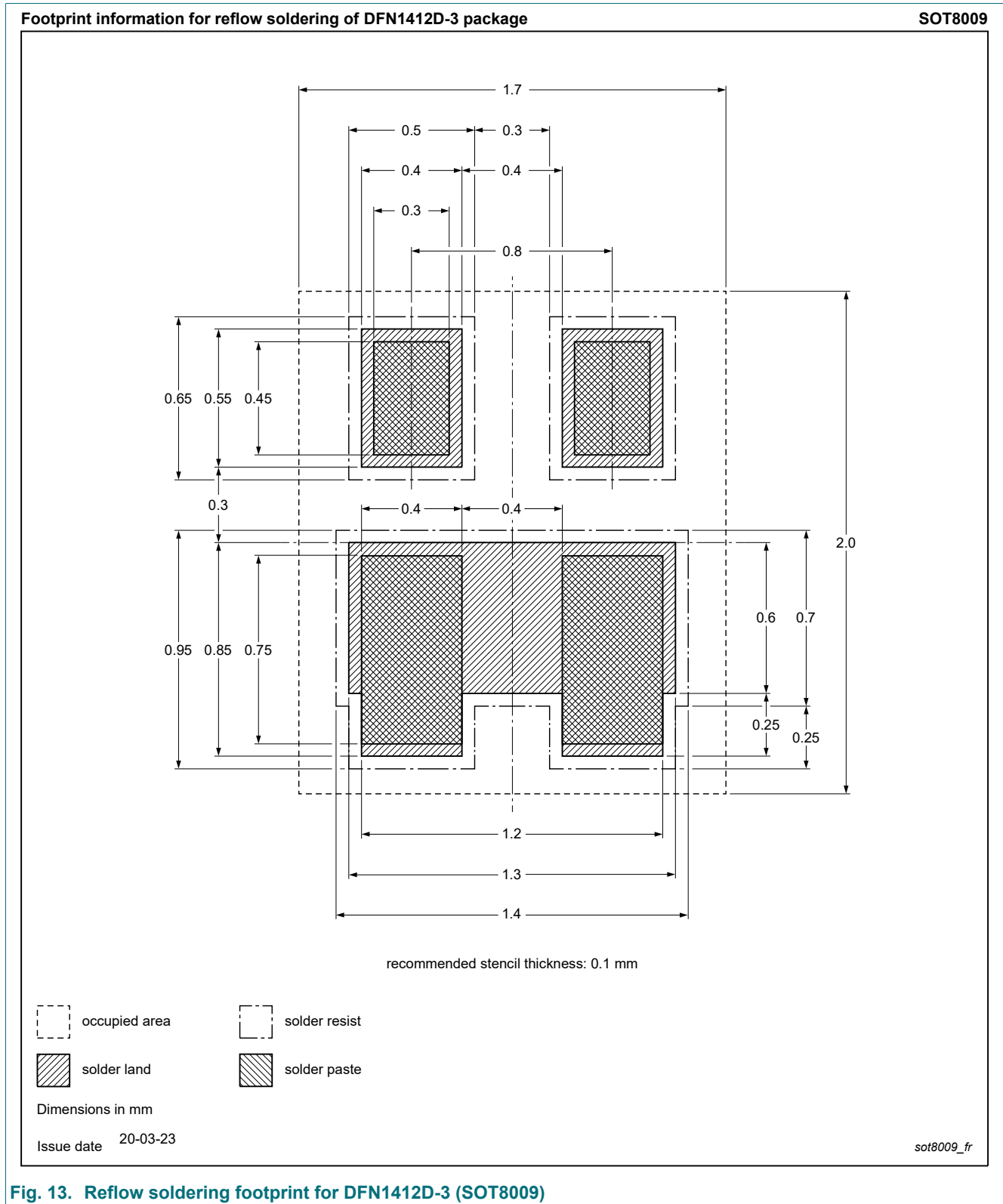


Fig. 13. Reflow soldering footprint for DFN1412D-3 (SOT8009)

14. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC846xQC-Q_SER v.1	20210304	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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